

10/810,779

In the Specification

Please amend the title as follows:

~~Circuit Constructions, and Methods of Forming Regions of Differing Composition~~

~~Over a Substrate~~

At page 1, before the "Technical Field" section, insert:

RELATED PATENT DATA

This patent resulted from a divisional application of U.S. Patent Application Serial
now PAT 6,786,766
No. 10/443,354, which was filed May 21, 2003, which is a continuation-in-part application
now PAT 6,767,806
of U.S. Patent Application Serial No. 10/243,386, filed September 13, 2002; which is a
divisional application of U.S. Patent Application Serial No. 09/827,759, filed April 6, 2001
and now U.S. Patent Number 6,511,896.